

# 12V MOSFET Drivers with Output Disable for Single Phase Synchronous-Rectified Buck Converter

### **General Description**

The uP1991S is a dual, high voltage MOSFET driver optimized for driving two N-channel MOSFETs in a synchronous-rectified buck converter. Each driver is capable of driving a 5000pF capacitive load with 30ns transition time. This device combined with uPI multi-phase buck PWM controller forms a complete core voltage regulator for advanced micro-processors.

The uP1991S features anti-shoot-through protection that prevents cross-conduction of the external MOSFET while maintains minimum deadtime for optimized efficiency.

This part has integrated bootstrap switch to help minimize the external component count. Both gate drives are turned off by pulling low EN pin or high-impedance at PWM pin, preventing rapid output capacitor discharge during system shutdown.

This device also supports supply input under voltage lockout. The uP1991S is available in thermally enhanced WDFN3x3-8L package.

### **Ordering Information**

| Order Number | Package      | Top Marking |  |  |
|--------------|--------------|-------------|--|--|
| uP1991SDD8   | WDFN3x3 - 8L | uP1991S     |  |  |

#### Note:

- (1) Please check the sample/production availability with uPI representatives.
- (2) uPI products are compatible with the current IPC/ JEDEC J-STD-020 requirements. They are halogen-free, RoHS compliant and 100% matte tin (Sn) plating that are suitable for use in SnPb or Pb-free soldering processes.

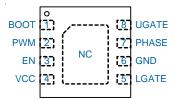
#### **Features**

- All-In-One Synchronous Buck Drivers
- Integrated Bootstrap Switch
- Anti-Shoot-Through Protection Circuitry
- 1 PWM Signal Generates both Drivers
- □ Tri-State Input for Bridge Shutdown
- Output Disable Control Turns Off both MOSFETs
- Under Voltage Lockout for Supply Input
- Allow PWM Pin as Multi-Function Setting Application
- RoHS Compliant and Halogen Free

### **Applications**

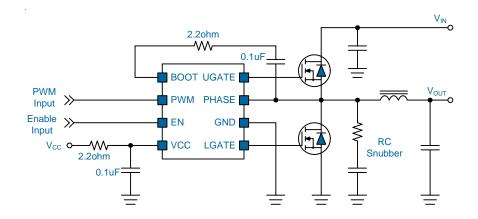
- Desktop CPU Core Voltage Regulators
- High Frequency Low Profile DC/DC Converter
- High Current Low Voltage DC/DC Converter

### **Pin Configuration**

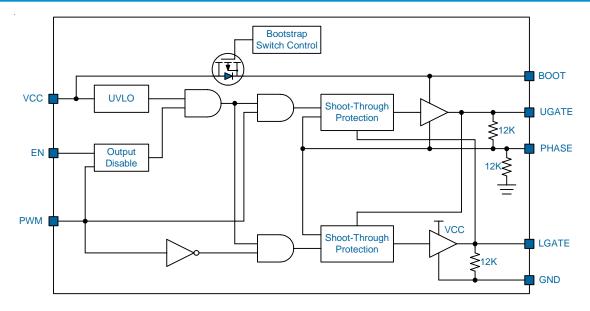




## **Typical Application Circuit**



### **Functional Block Diagram**





## **Functional Pin Description**

| Pin No.        | Pin Name | Pin Function                                                                                                                                                                                                                                                                                                                                                          |
|----------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1              | воот     | <b>Bootstrap Supply.</b> For the floating upper gate driver. Connect the bootstrap capacitor $C_{\text{BOOT}}$ between BOOT pin and the PHASE pin to form a bootstrap circuit. The bootstrap capacitor provides the charge to turn on the upper MOSFET. Make sure that $C_{\text{BOOT}}$ is placed near the IC.                                                       |
| 2              | PWM      | <b>PWM Input.</b> This pin receives logic level input and controls the driver outputs. The PWM pin is in high input impedance state if EN input is low. When EN input is high, the PWM pin voltage will be pulled to tri-state by internal circuit. The resistor connected from PWM pin to GND for PWM controller function setting must be greater than $15k\Omega$ . |
| 3              | EN       | <b>Enable Control.</b> This pin disables normal operation and forces both UGATE and LGATE off when it is pulled low. This pin also controls the state of PWM pin. When the EN pin is pulled low, the PWM pin is in high-input impedance state. There is no internal pull-up or pull-low mechanism to this pin.                                                        |
| 4              | VCC      | <b>Supply Voltage for the IC.</b> This pin provides bias voltage for the IC. Connect this pin to 12V voltage source and bypass it with an R/C filter.                                                                                                                                                                                                                 |
| 5              | LGATE    | <b>Lower Gate Driver Output.</b> Connect this pin to the gate of lower MOSFET. This pin is monitored by the shoot-through protection circuitry to determine when the lower MOSFET has been turned off.                                                                                                                                                                |
| 6              | GND      | Ground for the IC. All voltage levels are measured with respect to this pin.                                                                                                                                                                                                                                                                                          |
| 7              | PHASE    | PHASE Switch Node. Connect this pin to the source of the upper MOSFET and the drain of the lower MOSFET. This pin is used as the return path for the UGATE driver. This pin is also monitored by the shoot-through protection circuitry to determine when the upper MOSFET has been turned off.                                                                       |
| 8              | UGATE    | <b>Upper Gate Driver Output.</b> Connect this pin to the gate of upper MOSFET. This pin is monitored by the shoot-through protection circuitry to determine when the upper MOSFET has been turned off.                                                                                                                                                                |
| Exposed<br>Pad | NC       | Not Internally Connected. Although the exposed pad of uP1991S is not electrically connected to GND. It is still highly recommended to connect the exposed pad to GND plane for maximum heat dissipation.                                                                                                                                                              |



### **Functional Description**

#### **Enable Control**

The EN pin controls PWM pin state and the MOSFET gate driver output state. Logic input low to EN pin disables the gate drivers. Both UGATE and LGATE will be kept low, and PWM pin will be in high input impedance state. Logic input high to EN pin enables the gate drivers after a delay time  $T_{\rm PDHDEN}$  as shown in Figure 1. During this time period the PWM pin stays at high input impedance state, both UGATE and LGATE outputs are kept low, and the internal control circuit does not respond to the PWM input voltage. After  $T_{\rm PDHDEN}$  expires, both UGATE and LGATE begin to respond to the PWM input. This mechanism is specifically designed for uPI's PWM controller, which uses its PWM pin as a multi-functional pin.

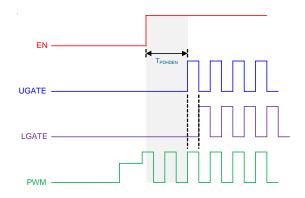


Figure 1. Enable Control, EN

#### **PWM Input**

The PWM pin is a tri-state input. Logic high turns on the high-side gate driver and turns off the low-side gate driver once the POR of VCC is granted and EN is kept high. Logic low turns off the high-side gate driver and turns on the low-side gate driver. High impedance input at PWM pin will keep both high-side and low-side gate drivers low and turns off both MOSFETs. The PWM pin voltage is kept around 1.6V by internal bias circuit when floating.

Refer to Figure 1, during T<sub>PDHDEN</sub>, both UGATE and LGATE are kept low, the PWM pin is in high-input impedance state, and the PWM input will be ignored. For the PWM controller uses its PWM pin as a multi-functional pin, a resistor will be connected from PWM pin to GND to set parameter. Note that this resistor must be greater than 15k $\Omega$ . Lower resistor value will cause incorrect PWM voltage level at the PWM pin when the PWM controller output is in tristate (high-impedance state).

#### **Low-Side Driver**

The low-side driver is designed to drive a ground referenced N-channel MOSFET. The bias to the low-side driver is internally connected to VCC supply and GND. The low-side driver output is out of phase with the PWM input when it is enabled. The low side driver is held low if the EN pin is pulled low or high-impedance at PWM pin.

#### **High-Side Driver**

The high-side driver is designed to drive a floating N-channel MOSFET. The bias voltage to the high-side driver is internally connected to BOOT and PHASE pins. An integrated bootstrap switch that is connected between BOOT and VCC pins provides the bias current for the high side gate driver.

The bootstrap capacitor  $C_{\rm BOOT}$  is charged to  $V_{\rm CC}$  when PHASE pin is grounded by turning on the low-side MOSFET. The PHASE rises to  $V_{\rm IN}$  when the high-side MOSFET is turned on, forcing the BOOT pin voltage to  $V_{\rm IN}$  +  $V_{\rm CC}$  that provides voltage to hold the high-side MOSFET on.

The high-side gate driver output is in phase with the PWM input when it is enabled. The high-side driver is held low if the EN pin is pulled low or high-impedance at PWM pin.

#### **Shoot Through Protection**

The shoot-through circuit prevents the high-side and lowside MOSFETs from being turned on simultaneously and conducting destructive large current. It is done by turning on one MOSFET only after the other MOSFET is off already with adequate delay time.

At the high-side off edge, UGATE and PHASE voltages are monitored for anti-shoot-through protection. The low-side driver will not begin to output high until both (V $_{\rm UGATE}$ -V $_{\rm PHASE}$ ) and V $_{\rm PHASE}$  are lower than 1.2V, making sure the high-side MOSFET is turned off completely.

At the low-side off edge, LGATE voltage is monitored for anti-shoot-through protection. The high-side driver will not begin to output high until  $V_{LGATE}$  is lower than 1.2V, making sure the low-side MOSFET is turned off completely.



## **Absolute Maximum Rating**

| (Note 1)                                                                |                                                                                                                         |
|-------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|
| Supply Input Voltage, VCC                                               |                                                                                                                         |
| BOOT to PHASE                                                           |                                                                                                                         |
| PHASE to GND                                                            |                                                                                                                         |
| DC                                                                      | 0.7V to +15V                                                                                                            |
| < 200ns                                                                 |                                                                                                                         |
| BOOT to GND                                                             |                                                                                                                         |
| DC                                                                      | 0.3V to (VCC +15V)                                                                                                      |
| < 200ns                                                                 |                                                                                                                         |
| UGATE to PHASE                                                          |                                                                                                                         |
| DC                                                                      | 0.3V to (BOOT - PHASE +0.3V)                                                                                            |
| < 200ns                                                                 |                                                                                                                         |
| LGATE to GND                                                            |                                                                                                                         |
| DC                                                                      |                                                                                                                         |
| < 200ns                                                                 |                                                                                                                         |
| PWM                                                                     |                                                                                                                         |
| EN                                                                      | 0.3V to (VCC +0.3V)                                                                                                     |
| Storage Temperature Range                                               |                                                                                                                         |
| Junction Temperature                                                    | 150°C                                                                                                                   |
| Lead Temperature (Soldering, 10 sec)                                    | 260°C                                                                                                                   |
| ESD Rating (Note 2)                                                     |                                                                                                                         |
| HBM (Human Body Mode)                                                   | 2kV                                                                                                                     |
| Thermal Information                                                     |                                                                                                                         |
| Package Thermal Resistance (Note 3)                                     |                                                                                                                         |
| WDFN3x3 - 8Lθ <sub>1Δ</sub>                                             | 68°C/W                                                                                                                  |
| WDFN3x3 - 8Lθ <sub>IC</sub>                                             |                                                                                                                         |
| Power Dissipation, $P_D @ T_{\Delta} = 25^{\circ}C$                     |                                                                                                                         |
| WDFN3x3 - 8L                                                            | 1.47W                                                                                                                   |
| <b>Recommended Operation Conditions</b>                                 |                                                                                                                         |
|                                                                         |                                                                                                                         |
| (Note 4) Operating Junction Temperature Range                           | 4000 to 142500                                                                                                          |
| Operating Ambient Temperature Range Operating Ambient Temperature Range |                                                                                                                         |
|                                                                         |                                                                                                                         |
| Supply Input Voltage, V <sub>CC</sub>                                   | 10.8V to 13.2V                                                                                                          |
|                                                                         | ese or any other conditions beyond those indicated in the<br>coosure to absolute maximum rating conditions for extended |

- periods may remain possibility to affect device reliability.

  Note 2. Devices are ESD sensitive. Handling precaution recommended.
- Note 3.  $\theta_{JA}$  is measured in the natural convection at  $T_A = 25^{\circ}\text{C}$  on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.
- Note 4. The device is not guaranteed to function outside its operating conditions.



### **Electrical Characteristics**

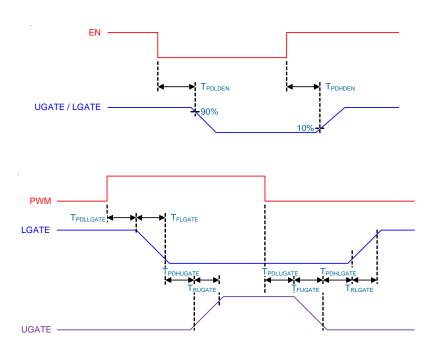
(VCC = 12V,  $T_A = 25$ °C, unless otherwise specified)

| Parameter                   | Symbol              | Test Conditions                                 | Min  | Тур  | Max  | Unit |  |
|-----------------------------|---------------------|-------------------------------------------------|------|------|------|------|--|
| Supply Input                |                     |                                                 |      |      |      |      |  |
| Supply Current              | I <sub>cc</sub>     | EN = 0V                                         |      | 1    | 3    | mA   |  |
| VCC POR Rising Threshold    | V <sub>CCRTH</sub>  | V <sub>cc</sub> rising                          |      | 4.2  |      | V    |  |
| VCC POR Hysteresis          | V <sub>CCHYS</sub>  |                                                 |      | 0.25 |      | V    |  |
| PWM Input                   |                     |                                                 |      |      |      |      |  |
| Input High Level            | PWM <sub>H</sub>    |                                                 | 2.9  |      |      | V    |  |
| Input Low Level             | PWM <sub>L</sub>    |                                                 |      |      | 0.4  | V    |  |
| PWM Floating Voltage        | PWM <sub>FLT</sub>  |                                                 |      | 1.6  |      | V    |  |
| PWM Input Current           |                     | PWM = 0V                                        | -520 | -280 | -200 | uA   |  |
|                             | I <sub>PWM</sub>    | PWM = 3.3V                                      | 0.5  | 1    | 1.6  | mA   |  |
|                             |                     | PWM = 5V                                        | 1    | 2    | 2.6  | mA   |  |
| Enable Control              |                     |                                                 |      |      |      |      |  |
| Input High                  | EN <sub>H</sub>     |                                                 | 2    |      |      | V    |  |
| Input Low                   | EN <sub>L</sub>     |                                                 |      |      | 0.6  | V    |  |
|                             | T <sub>PDHDEN</sub> |                                                 | 1    | 2    | 3    | us   |  |
| Propagation Delay Time      | T <sub>PDLDEN</sub> |                                                 | 60   | 80   | 100  | ns   |  |
| Bootstrap Switch            | •                   |                                                 | •    | •    |      |      |  |
| On Resistance               | R <sub>DS(ON)</sub> | Forward bias current = 1mA                      |      | 40   |      | Ω    |  |
| High Side Driver            |                     |                                                 |      |      |      |      |  |
| Output Resistance, Sourcing | R <sub>H_SRC</sub>  | $V_{BOOT} - V_{PHASE} = 12V, I_{UGATE} = 80mA$  |      | 2    | 4    | Ω    |  |
| Output Resistance, Sinking  | R <sub>H_SNK</sub>  | $V_{BOOT} - V_{PHASE} = 12V, I_{UGATE} = -80mA$ |      | 1    | 2    | Ω    |  |
| Output Rising Time          | T <sub>RUGATE</sub> | $V_{BOOT} - V_{PHASE} = 12V, C_{LOAD} = 3nF$    |      | 35   | 45   | ns   |  |
| Output Falling Time         | T <sub>FUGATE</sub> | $V_{BOOT} - V_{PHASE} = 12V, C_{LOAD} = 3nF$    |      | 20   | 30   | ns   |  |
| Propagation Delay Time      | T <sub>PDHUG</sub>  | V <sub>BOOT</sub> - V <sub>PHASE</sub> = 12V    |      | 40   | 65   | no   |  |
|                             | T <sub>PDLUG</sub>  | V <sub>BOOT</sub> - V <sub>PHASE</sub> = 12V    |      | 20   | 35   | ns   |  |



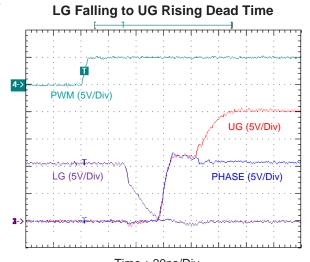
## **Electrical Characteristics**

| Parameter                   | Symbol              | Test Conditions                       | Min | Тур | Max | Unit |  |
|-----------------------------|---------------------|---------------------------------------|-----|-----|-----|------|--|
| Low Side Driver             |                     |                                       |     |     |     |      |  |
| Output Resistance, Sourcing | R <sub>L_SRC</sub>  | $V_{CC} = 12V$ , $I_{LGATE} = 80mA$   |     | 2   | 4   | Ω    |  |
| Output Resistance, Sinking  | R <sub>L_SNK</sub>  | $V_{CC} = 12V$ , $I_{LGATE} = -80$ mA |     | 0.8 | 1.6 | Ω    |  |
| Output Rising Time          | T <sub>RLGATE</sub> | $V_{CC} = 12V, C_{LOAD} = 3nF$        |     | 35  | 45  | ns   |  |
| Output Falling Time         | T <sub>FLGATE</sub> | $V_{CC} = 12V, C_{LOAD} = 3nF$        |     | 20  | 30  | ns   |  |
| Propagation Delay Time      | T <sub>PDHLG</sub>  | V <sub>cc</sub> = 12V                 |     | 40  | 65  | ns   |  |
|                             | T <sub>PDLLG</sub>  | V <sub>cc</sub> = 12V                 |     | 20  | 35  | ns   |  |

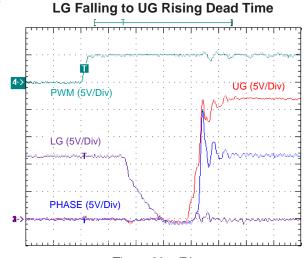




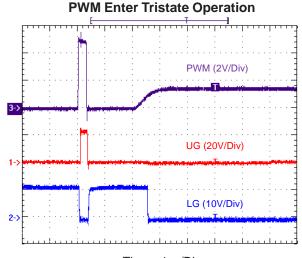
## **Typical Operation Characteristics**



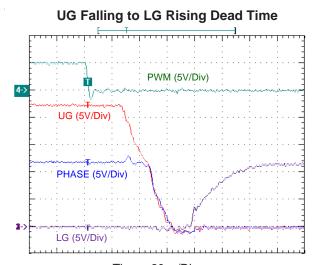
 $\label{eq:VN} Time: 20ns/Div \\ V_{IN} = 12 \text{V,V}_{CC} = 12 \text{ V, Converter Load} = 0 \text{A,HSFET} = \\ QM3004*2, LSFET = QM3006*2, RC Snubber R=2.2 \Omega, C = 3.3 nF \\ \end{array}$ 



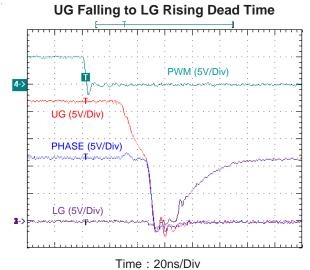
 $\label{eq:VN} Time: 20ns/Div $$V_{N}=12V,V_{CC}=12\ V, \ Converter\ Load=20A,\ HSFET=QM3004*2,LSFET=QM3006*2,\ RC\ Snubber\ R=2.2\Omega,\ C=3.3nF$ 



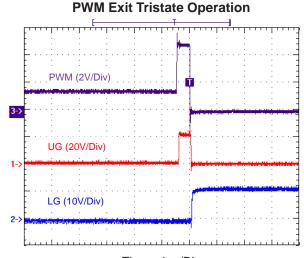
Time : 1us/Div  $V_{IN}$ =12V, $V_{CC}$ =12 V, Converter Load = 0A, HSFET = QM3004\*2,LSFET=QM3006\*2



 $\label{eq:VN} Time: 20ns/Div \\ V_{IN} = 12 \text{V,V}_{CC} = 12 \text{ V, Converter Load} = 0 \text{A, HSFET} = \\ QM3004*2, LSFET = QM3006*2, RC Snubber R=2.2 \Omega, C = 3.3 \text{nF} \\$ 



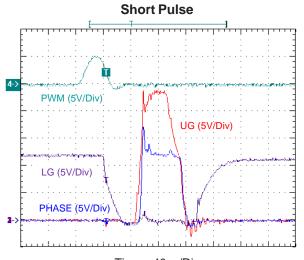
 $V_{IN}$ =12V, $V_{CC}$ =12 V, Converter Load = 20A, HSFET = QM3004\*2,LSFET=QM3006\*2, RC Snubber R=2.2 $\Omega$ , C = 3.3nF



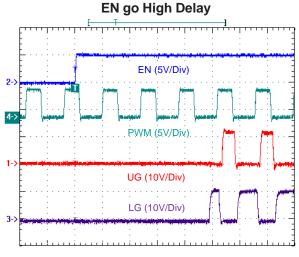
 $\label{eq:local_control_control} \begin{aligned} & \text{Time: 1us/Div} \\ \textbf{V}_{\text{IN}} = 12 \text{V,V}_{\text{CC}} = 12 \text{ V, Converter Load} &= 0 \text{A,} \\ & \text{HSFET} = \text{QM3004*2,LSFET} = \text{QM3006*2} \end{aligned}$ 



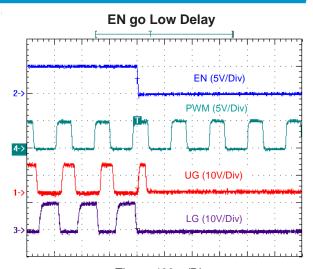
## **Typical Operation Characteristics**



 $\label{eq:local_local_local} Time: 40ns/Div \\ V_{_{IN}}\!\!=\!\!12V, V_{_{CC}}\!\!=\!\!12~V, PWM\!=\!\!30ns, Converter~Load=5A, \\ HSFET\!=\!QM3004^*2, LSFET\!=\!QM3006^*2$ 



 $\label{eq:constraints} \begin{aligned} & \text{Time: 400ns/Div} \\ & \text{V}_{\text{CC}} = 12\text{V, PWM} = 1.8\text{MHz, D=40\%,} \\ & \text{HSFET} = \text{QM3004*2,LSFET=QM3006*2} \end{aligned}$ 

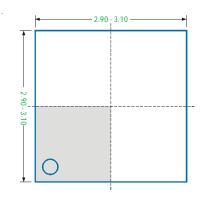


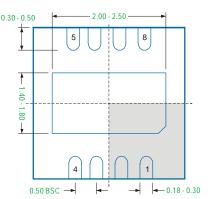
 $\label{eq:Vcc} Time: 400 ns/Div \\ V_{cc} = 12 V, PWM = 1.8 MHz, D = 40\% \\ HSFET = QM3004*2, LSFET = QM3006*2$ 



## **Packaging Information**

#### WDFN3x3-8L







#### Note

1. Package Outline Unit Description:

BSC: Basic. Represents theoretical exact dimension or dimension target

MIN: Minimum dimension specified.

MAX: Maximum dimension specified.

REF: Reference. Represents dimension for reference use only. This value is not a device specification.

TYP. Typical. Provided as a general value. This value is not a device specification.

- 2. Dimensions in Millimeters.
- 3. Drawing not to scale.
- 4. These dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm.



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